TRANSMITTAL

Electronic Version v1.1

Stylesheet Version v1.1.0

Title of Invention	[BUMP LAYOUT ON SILICON CHIP]	
Application Number :		
Date :		
First Named Applica	nt: Mr. Wen-Chih Yang	
Confirmation Number	r.	
	Topo UC DA 4	

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Submitted By:	Elec. Sign.	Sign. Capacity
Dr. Belinda Lee Registered Number: 46,863	/Belinda Lee/	Agent

Documents being submitted:	Files
	7000 D
us-request	7808-D-usrequ.xml
	us-request.dtd
	us-request.xsl
us-fee-sheet	7808-D-usfees.xml
	us-fee-sheet.xsl
	us-fee-sheet.dtd
us-declaration	7808declaration1.tif
us-declaration	7808declaration2.tif
application-body	7808-D-trans.xml
	us-application-body.xsl
	application-body.dtd
	wipo.ent
	mathml2.dtd
	mathml2-qname-1.mod
	isoamsa.ent
	isoamsb.ent
	isoamsc.ent
	isoamsn.ent
	isoamso.ent
	isoamsr.ent
	isogrk3.ent
	isomfrk.ent
	isomopf.ent
	isomscr.ent
	isotech.ent
	isobox.ent
	isocyr1.ent
	isocyr2.ent
	isodia.ent
	isolat1.ent
	isolat2.ent
	isonum.ent
	isopub.ent
	mmlextra.ent
	mmlalias.ent
	soextblx.dtd
	7808US0001.tif
	7808US0002.tif
	7808US0003.tif

Comments

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